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No. 99-302



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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party:  
William A. Moffat

2. Name and address of receiving party:

3. Nature of conveyance:  
☒ Assignment ☐ Merger  
☐ Security Agreement  
☐ Other

Name: Yield Engineering Systems, Inc.

Address: 2119 Oakland Road  
San Jose, CA 95131

Execution Date: November 24, 1999

4. Application number or patent number: 09/449062

If this document is being filed with a new application, the execution date of the application is: November 24, 1999

A. Patent Application No.

B. Patent No.

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Donald J. Pagel  
Law Office of Donald J. Pagel  
603 N. San Pedro St.  
San Jose, CA 95110

6. Total number of applications and patents involved: one

7. Total fee \$ 40.00  
☒ Enclosed  
☐ Charge deposit account

8. Deposit Acct. No.

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9. Statement and signature:

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Donald J. Pagel  
Name of Person Signing

DPagel  
Signature

11/24/99  
Date

Total number of pages including cover sheet: 2

JC688 U.S. PRO  
09/449062

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Express Mail No. EK041049405US

ASSIGNMENT

Whereas, I

INVENTOR

AND CITY

(1) William A. Moffat, of San Jose,  
County of Santa Clara and State of California;

have invented certain improvements in a

TITLE

"RAPID HEATING AND COOLING VACUUM OVEN"

DATE THAT

INVENTOR

SIGNED THE

DECLARATION

and executed a United States patent application therefor on

(1) March 1, 1999, 1999,

Whereas YIELD ENGINEERING SYSTEMS, INC., a corporation of California, having a place of business at 2119 Oakland Road, San Jose, CA 95131, desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I, the above named, hereby sell, assign, and transfer to YIELD ENGINEERING SYSTEMS, INC., its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and I request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to YIELD ENGINEERING SYSTEMS, INC., its successors and assigns; and I hereby agree that YIELD ENGINEERING SYSTEMS, INC. may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by YIELD ENGINEERING SYSTEMS, INC.

Signed and sealed

CITY

(1) at San Jose

DATE

on March 1, 1999, 1999,

  
William A. Moffat

SIGNATURE  
INVENTOR

Express Mail No.: EK041049406US